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INSTRUCTION

Subject:	Distribution				Classification
	JA	\boxtimes	JP	\square	Product Spec./ Test report
UB connector (MicroUSB)	JAU	\boxtimes	JS	\boxtimes	Standards
	JD	\boxtimes	JSH	\boxtimes	Drawing
	JB	\boxtimes	JSK	\boxtimes	Manual \square
File No.:	JF	\boxtimes	JT	\boxtimes	Engineering Information
EE-092	JH	\boxtimes	JUK	\boxtimes	Dies Construction Sheet
	JIS	\boxtimes	JW	\boxtimes	Exploded View
	JMK	\boxtimes	JJ	\boxtimes	Engineering Change Notice
	JMP	\boxtimes	MEA	\boxtimes	All Others
	JOE	\boxtimes			

UB connector (MicroUSB) Embossed carrier tape

Material and thickness for embossed carrier tape of UB connector (MicroUSB) shall be changed one by one as follows.

1. Target product

UB connector (MicroUSB)

Model No.: UB-MC5BR3-SD204-4S-1-TB NMP (B type)

UB-MC5ABR3-SD204-4S-1-TB NMP (AB type)

2. Details of change

Material for embossed carrier tape of aforementioned product shall be changed from A-PET to PS. At the same time, thickness of carrier tape shall be changed from 0.3 mm (A-PET) to 0.4 mm (PS).

3. Reason for change

<Change of material>

In order to improve heat resistance of embossed carrier tape.

(Countermeasure the thermal contraction deformation.)

<Change of thickness>

In order to enhance the strength of carrier tape.

(In order to prevent the pilot hole from deforming and to reduce the generation of flash around the hole.)

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